



## DMN5/L06VK/L06VAK/010VAK

#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

Case Material: Molded Plastic, "Green" Molding Compound.

Terminals: Finish – Matte Tin Annealed over Copper Leadframe.

UL Flammability Classification Rating 94V-0 Moisture Sensitivity: Level 1 per J-STD-020

Solderable per MIL-STD-202, Method 208 @3

Terminal Connections: See Diagram

Weight: 0.006 grams (Approximate)

#### Features

- **Dual N-Channel MOSFET**
- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V max
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- ESD Protected up to 2kV
- Qualified to AEC-Q101 standards for High Reliability



ESD protected up to 2kV

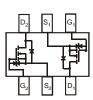


**SOT563** Top View



**Mechanical Data** 

Case: SOT563



DMN5L06VK

DMN5L06VAK DMN5010VAK

#### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN5L06VK-7	SOT563	3,000/Tape & Reel
DMN5L06VK-13	SOT563	10,000/Tape & Reel
DMN5L06VAK-7	SOT563	3,000/Tape & Reel
DMN5L06VAK-13	SOT563	10,000/Tape & Reel
DMN5010VAK-7	SOT563	3,000/Tape & Reel
DMN5010VAK-13	SOT563	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

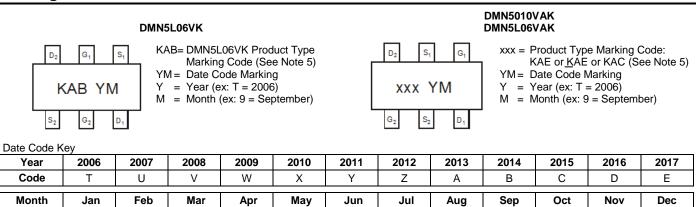
2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

#### Marking Information (Note 5)

Notes:



Note:	5. Package is non-polarized. Parts may be on reel in orientation illustrated, 180° rotated, or mixed (both ways).

5

4

1

2

3

Code

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9

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Ν

D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Charact	eristic	Symbol	Value	Unit
Drain Source Voltage		V <sub>DSS</sub>	50	V
Drain-Gate Voltage $R_{GS} \le 1.0M\Omega$		V <sub>DGR</sub>	50	V
Gate-Source Voltage	Continuous Pulsed	V <sub>GSS</sub>	±20 ±40	V
Drain Current (Note 6)	Continuous Pulsed	I <sub>D</sub> I <sub>DM</sub>	280 1.5	mA A

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>0JA</sub>	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

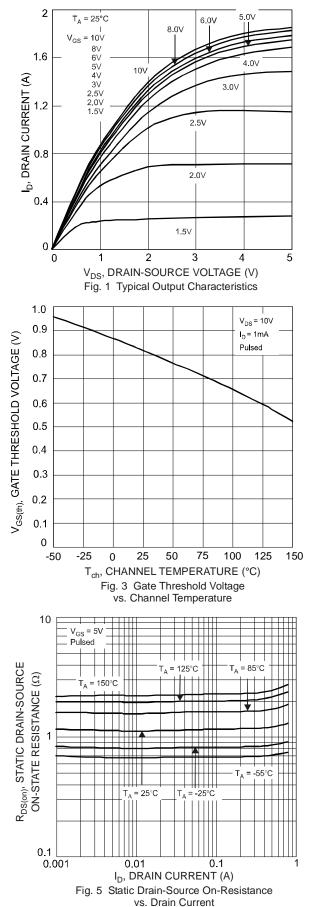
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)					•	•	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	50	—	—	V	$V_{GS} = 0V$ , $I_D = 10\mu A$	
Zero Gate Voltage Drain Current $@ T_C = +25^{\circ}C$	I <sub>DSS</sub>	-	—	60	nA	$V_{DS} = 50V, V_{GS} = 0V$	
Gate-Body Leakage	I <sub>GSS</sub>		_	1 500 50	μA nA nA	$V_{GS} = \pm 12V, V_{DS} = 0V$ $V_{GS} = \pm 10V, V_{DS} = 0V$ $V_{GS} = \pm 5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage $@T_J = +25^{\circ}C$ $@T_J = +0^{\circ}C \sim +85^{\circ}C$ (Note 8)	V <sub>GS(th)</sub>	0.49 0.30	_	1.0 1.2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>			3.0 2.5 2.0	Ω		
On-State Drain Current	I <sub>D(ON)</sub>	0.5	1.4	—	Α	$V_{GS} = 10V, V_{DS} = 7.5V$	
Forward Transconductance	Y <sub>fs</sub>	200	—	—	mS	V <sub>DS</sub> =10V, I <sub>D</sub> = 0.2A	
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	0.5	—	1.4	V	$V_{GS} = 0V, I_{S} = 115mA$	
DYNAMIC CHARACTERISTICS (Note 8)					•	•	
Input Capacitance	Ciss	_	—	50	pF	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V f = 1.0MHz	
Output Capacitance	Coss	_	_	25	pF		
Reverse Transfer Capacitance	Crss	_	—	5.0	pF		

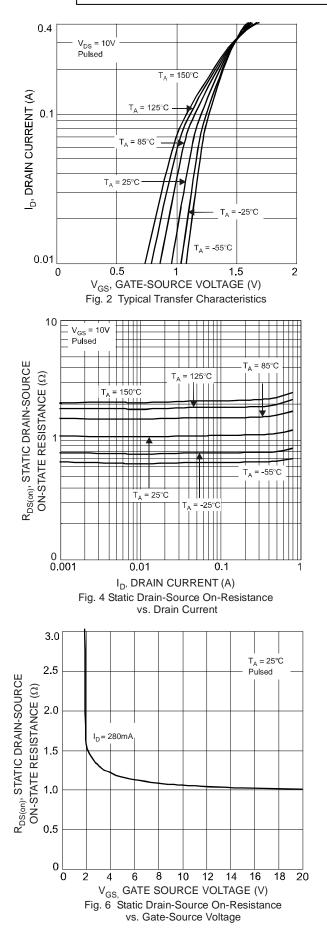
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Short duration pulse test used to minimize self-heating effect. Notes:

8. Guaranteed by design. Not subject to product testing.



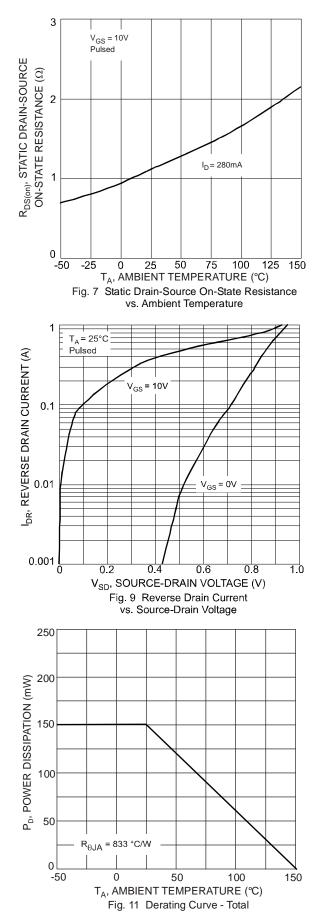


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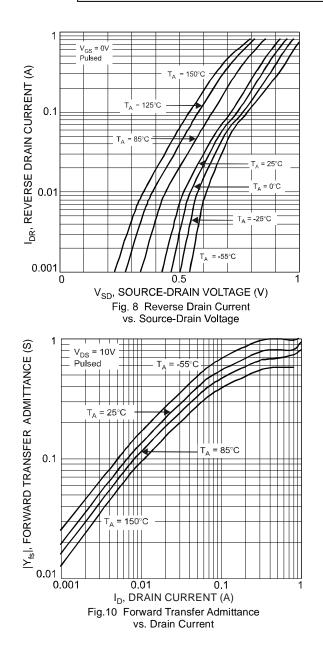


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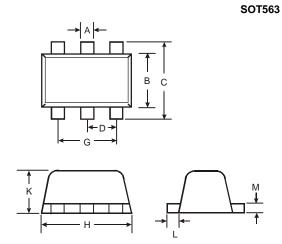
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### **Package Outline Dimensions**

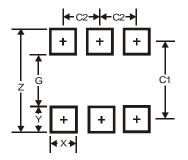
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT563					
Dim	Min	Max	Тур		
Α	0.15	0.30	0.20		
В	1.10	1.25	1.20		
С	1.55	1.70	1.60		
D	-	-	0.50		
G	0.90	1.10	1.00		
Н	1.50	1.70	1.60		
Κ	0.55	0.60	0.60		
L	0.10	0.30	0.20		
М	0.10	0.18	0.11		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5

SOT563



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